

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit
LED	Forward current	I _F	50	mA
	Forward current derating (Ta ≥ 25°C)	ΔI _F / °C	-0.5	mA / °C
	Pulse forward current (100 μs pulse, 100 pps)	I _{FP}	1	A
	Reverse voltage	V _R	3	V
	Diode power dissipation	P _D	100	mW
	Diode power dissipation derating (Ta ≥ 25°C)	ΔP _D / °C	-1.0	mW/°C
	Junction temperature	T _j	125	°C
Detector	Forward current	I _{FD}	50	μA
	Reverse voltage	V _{RD}	10	V
	Output power dissipation	P _O	0.5	mW
	Junction temperature	T _j	125	°C
Storage temperature range		T _{stg}	-55 to 125	°C
Operating temperature range		T _{opr}	-40 to 85	°C
Lead soldering temperature (10 s)		T _{sol}	260	°C
Isolation voltage (AC, 60 s, R.H. ≤ 60 %) (Note 1)		BV _S	2500	V _{rms}

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Device considered a two terminal device: Pins 1, 2 and 3 shorted together, and pins 4 and 6 shorted together.

Recommended Operating Conditions

Characteristic	Symbol	Min	Typ.	Max	Unit
Forward current	I _F	—	20	25	mA
Operating temperature	T _{opr}	-25	—	85	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Electrical Characteristics (Ta = 25°C)

Characteristic		Symbol	Test Condition	Min	Typ.	Max	Unit
LED	Forward voltage	V_F	$I_F = 10 \text{ mA}$	1.2	1.4	1.7	V
	Reverse current	I_R	$V_R = 3 \text{ V}$	—	—	10	μA
	Capacitance	C_T	$V = 0 \text{ V}, f = 1 \text{ MHz}$	—	30	60	pF
Detector	Forward voltage	V_{FD}	$I_{FD} = 10 \mu\text{A}$	—	7	—	V
	Reverse current	I_{RD}	$V_{RD} = 10 \text{ V}$	—	1	—	nA

Coupled Electrical Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min	Typ.	Max	Unit
Open voltage	V_{OC}	$I_F = 10 \text{ mA}$	7.0	8.0	—	V
Short current	I_{SC}	$I_F = 10 \text{ mA}$	12	20	—	μA

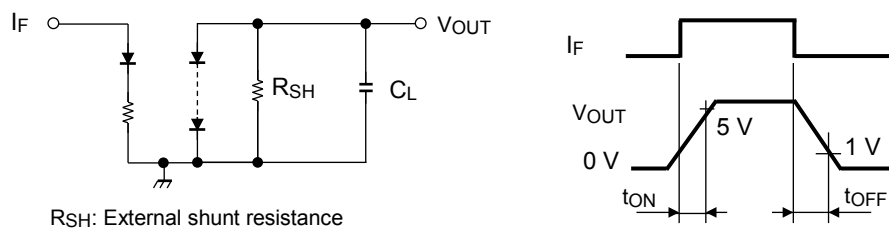
Isolation Characteristics (Ta = 25°C)

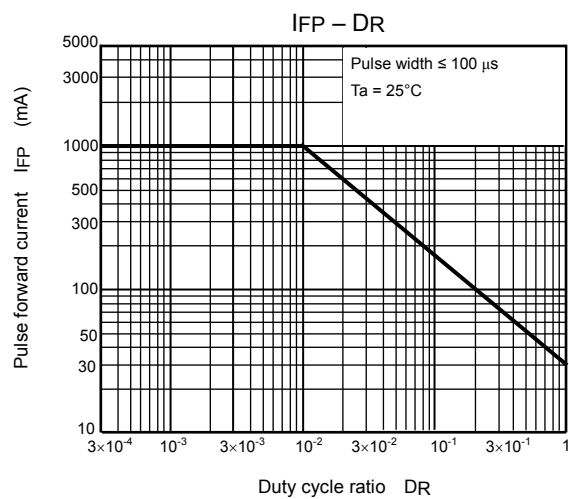
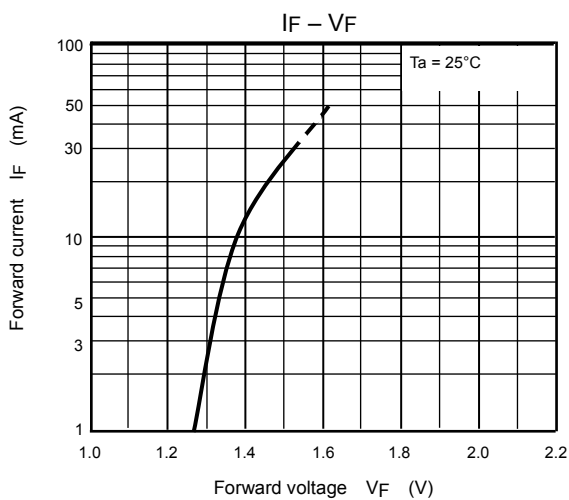
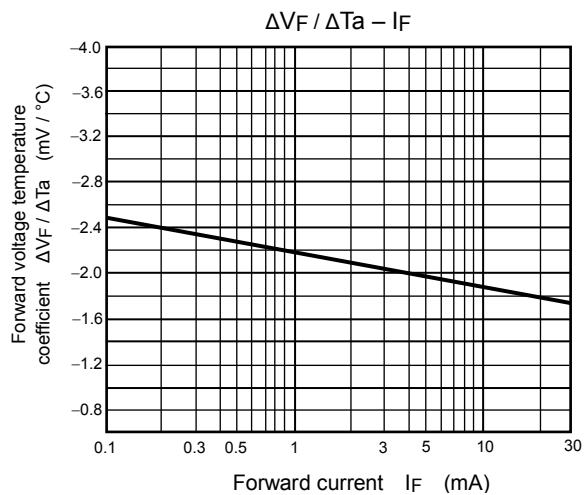
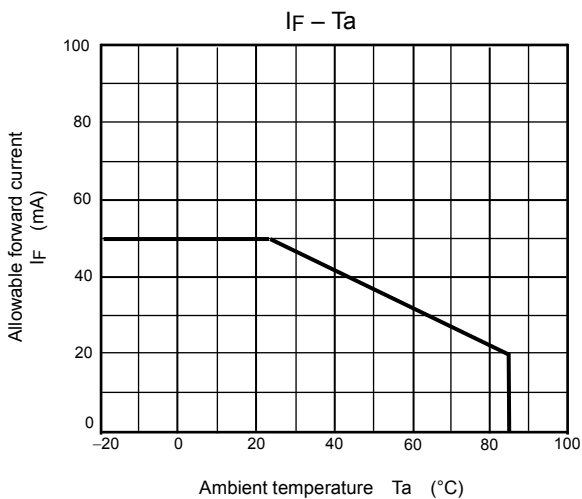
Characteristic	Symbol	Test Condition	Min	Typ.	Max	Unit
Capacitance input to output	C_S	$V_S = 0 \text{ V}, f = 1 \text{ MHz}$	—	0.8	—	pF
Isolation resistance	R_S	$V_S = 500 \text{ V}, \text{R.H.} \leq 60 \%$	5×10^{10}	10^{14}	—	Ω
Isolation voltage	BV_S	AC, 60 s	2500	—	—	V _{rms}

Switching Characteristics (Ta = 25°C)

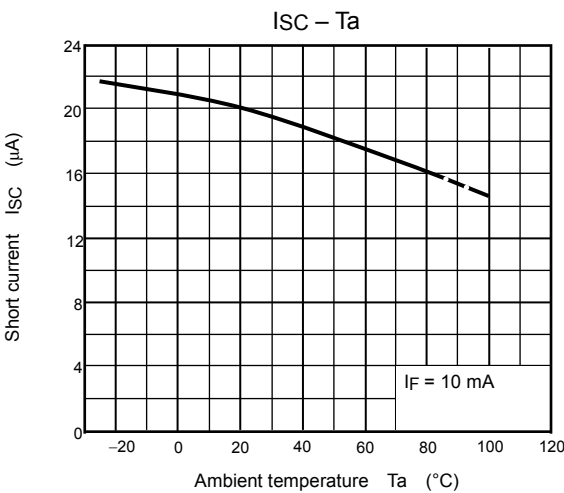
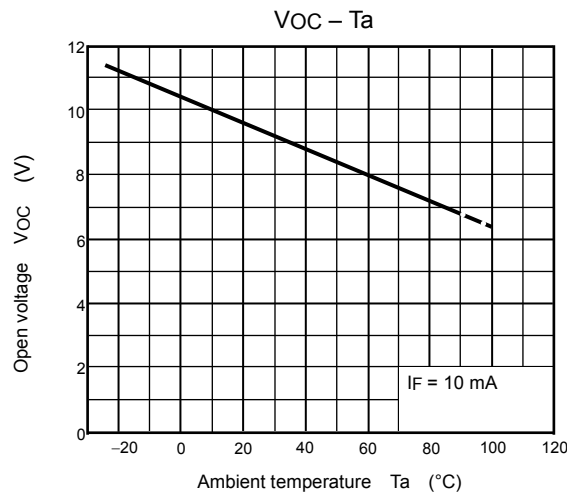
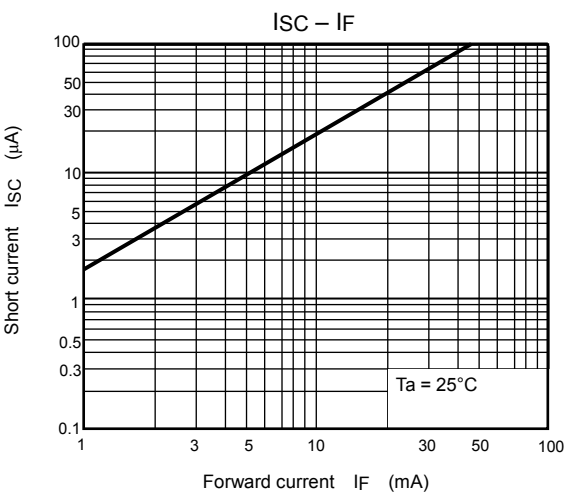
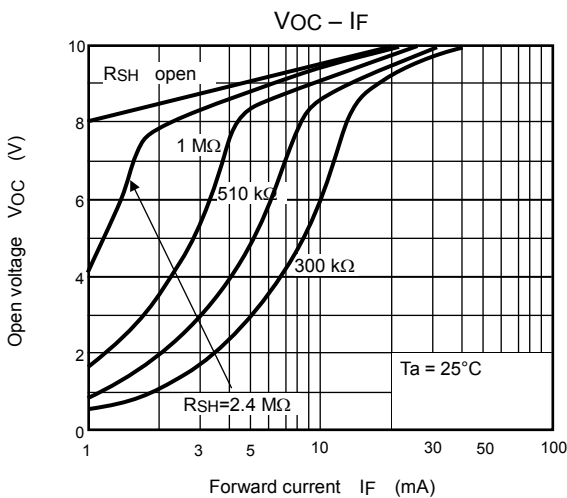
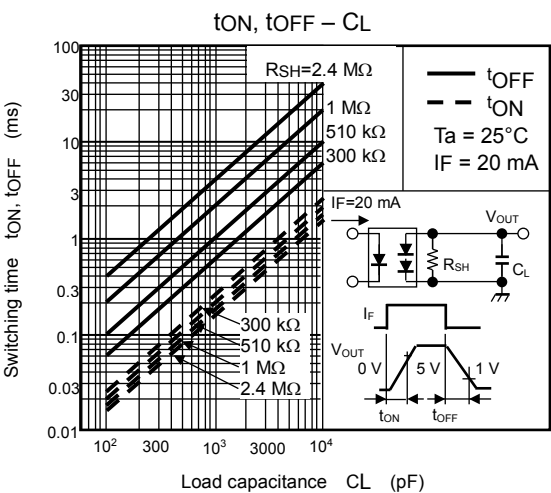
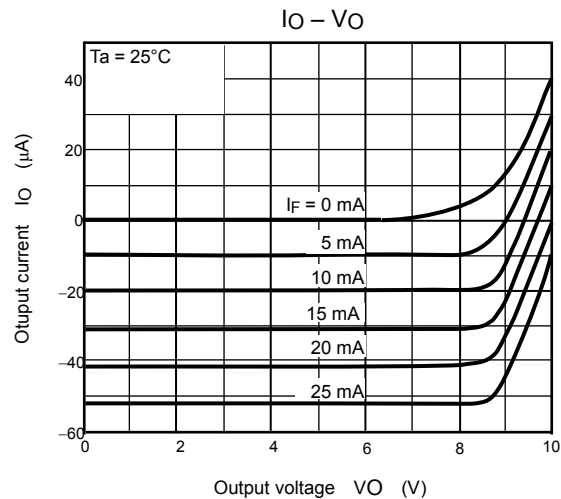
Characteristic	Symbol	Test Condition	Min	Typ.	Max	Unit
Turn-on time	t_{ON}	$I_F = 20 \text{ mA}, R_{SH} = 510 \text{ k}\Omega$ $C_L = 1000 \text{ pF}$ (Note 2)	—	0.2	—	ms
Turn-off time	t_{OFF}		—	1	—	ms

Note 2: Switching time test circuit





NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



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